

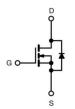
Sinai Power Technologies

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N-channel Power MOSFET

PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	700		
R _{DS(on)} max. at 25°C (mΩ)	V _{GS} =10V	90	
Q _g max. (nC)	8	5	
Q _{gs} (nC)	1	5	
Q _{gd} (nC)	2	5	
Configuration	sin	gle	





TO-220F

Schematic diagram

Features

- New Technology For High Voltage Device
- ID=30A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- RoHS compliant

Applications

- Switching Mode Power Supplies (SMPS)
- Server and Telecom Power Supplies
- Welding& Battery Chargers
- Solar(PV Inverters)
- AC/DC Bridge Circuits

ORDERING INFORMATION				
Device	SPC65R90G			
Device Package	TO-220F			
Marking	65R90G			

ABSOLUTE MAXIMUM RATINGS (Tc = 25°C, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain to Source Voltage	V _{DSS}	650	V		
Continuous Drain Current (@T _C =25°C)		30 (1)	А		
Continuous Drain Current (@T _C =100°C)	I _D	19 ⁽¹⁾	Α		
Drain current pulsed (2)	I _{DM}	90 (1)	А		
Gate to Source Voltage	V _{GS}	±30	V		
Single pulsed Avalanche Energy (3)	E _{AS}	810	mJ		
MOSFET dv/dt ruggedness (@V _{DS} =0~400V)	dv/dt	25	V/ns		
Peak diode Recovery dv/dt (4)	dv/dt	15	V/ns		
Total power dissipation (@T _C =25°C)	P _D	33.8	W		
Derating Factor above 25°C	' D	0.27	W/ºC		
Operating Junction Temperature & Storage Temperature	T _{STG} , T _J	-55 to + 150	°C		
Maximum lead temperature for soldering purpose	TL	260	°C		
Mounting torque (5)		0.4~0.6	N.m		

Notes

- 1. Drain current is limited by maximum junction temperature.
- 2. Repetitive rating : pulse width limited by junction temperature.
- 3 L =20mH, I_{AS} = 9A, V_{DD} = 50V, R_{G} =25 Ω , Starting at T_{J} = 25 $^{\circ}$ C
- I_{SD} ≤ I_D, di/dt = 100A/us, V_{DD} ≤ BV_{DSS}, Starting at T_J =25°C
 Mounting consideration for TO220 Fullpack:
- M3 screw plus flat washer is suggested, free of burr between devices and contact area, the devices are to be mounted to a hole not larger than 3.6mm in contact diameter (chamfer included).



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THERMAL CHARACTERISTICS				
Parameter	Symbol	Value	Unit	
Thermal resistance, Junction to case	R _{thjc}	3.7	°C/W	
Thermal resistance, Junction to ambient	R _{thja}	38	°C/W	

ELECTRICAL CHARACTERISTICS (To	ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Off Characteristics							
Drain to source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	650			V	
Breakdown voltage temperature coefficient	ΔBV _{DSS} / ΔTJ	I _D =250uA, referenced to 25°C		0.38		V/°C	
Durain to a compa la alcana accurant		V _{DS} =650V, V _{GS} =0V			1	uA	
Drain to source leakage current	I _{DSS}	V _{DS} =520V, T _C =125°C			50	uA	
Gate to source leakage current, forward	1	V _{GS} =30V, V _{DS} =0V			100	nA	
Gate to source leakage current, reverse	I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA	
On Characteristics							
Gate threshold voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.5		4.5	V	
Drain to source on state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A		80	90	mΩ	
Forward Transconductance	Gfs	$V_{DS} = 30 \text{ V}, I_{D} = 15 \text{A}$		28		S	
Gate Resistance	Rg	$V_{DS} = 0 V$		1.2		Ω	
Dynamic Characteristics							
Input capacitance	C _{iss}			3010			
Output capacitance	Coss	V_{GS} =0V, V_{DS} =200V, f=1MHz		102		pF	
Reverse transfer capacitance	C _{rss}	V _{GS} =0V, V _{DS} =200V, f=1MHz		2.5		1	
Turn on delay time	t _{d(on)}			32			
Rising time	tr	V _{DS} =320V, I _D =15A ,		72			
Turn off delay time	t _{d(off)}	R_G =25 Ω		110		ns	
Fall time	t _f			67			
Total gate charge	Qg	V _{DS} =520V, V _{GS} =10V, I _D =30A		65	85		
Gate-source charge	Q _{gs}			15		nC	
Gate-drain charge	Q_{gd}			25			

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS							
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Continuous source current	Is	Integral reverse p-n Junction diode in the MOSFET	-		30	Α	
Pulsed source current	I _{SM}				90	Α	
Diode forward voltage drop.	V _{SD}	I _S =30A, V _{GS} =0V	-	0.9	1.2	V	
Reverse recovery time	Trr	I _S =15A, V _{GS} =0V, dI _F /dt=100A/us		405		ns	
Reverse recovery Charge	Qrr			6.8		uC	

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Fig1. Output characteristics

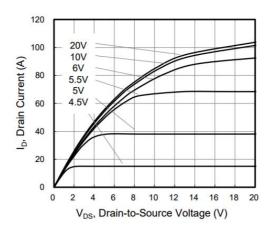


Fig3. Gate charge characteristics

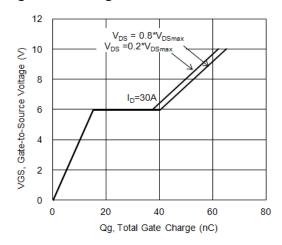


Fig 5. RDS(ON) vs junction temperature

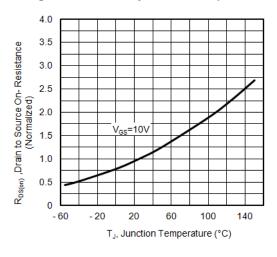


Fig2. Maximum Drain Current vs. Case Temperature

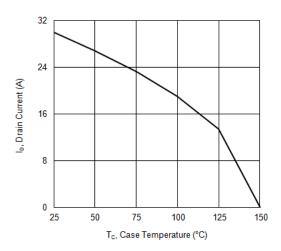


Fig 4. Capacitance Characteristics

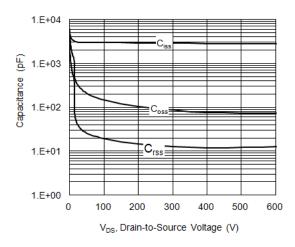
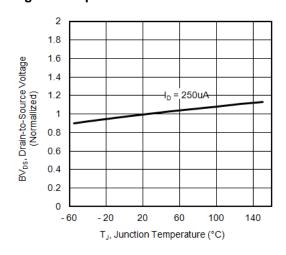


Fig 6. - Temperature vs. Drain-to-Source Voltage



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Fig 7. Safe operating area

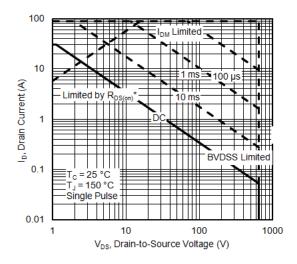


Fig 8. Forward characteristics of reverse diode

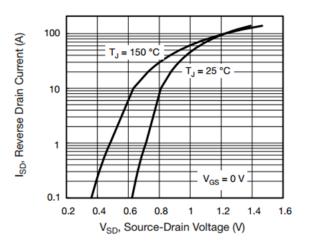


Fig 9. Transient thermal impedance

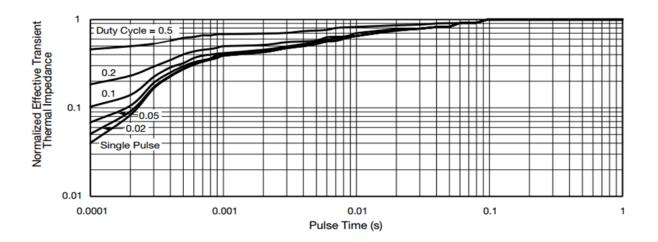
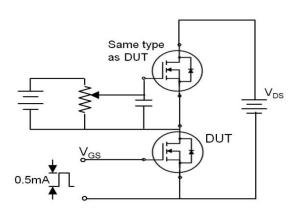
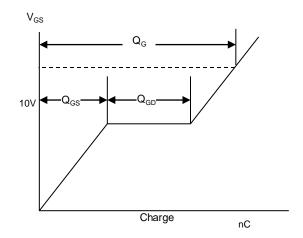


Fig 10. Gate charge test circuit & waveform





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Fig 11. Switching time test circuit & waveform

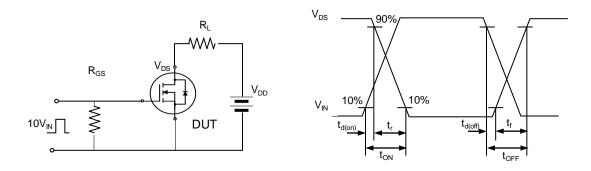


Fig 12. Unclamped Inductive switching test circuit & waveform

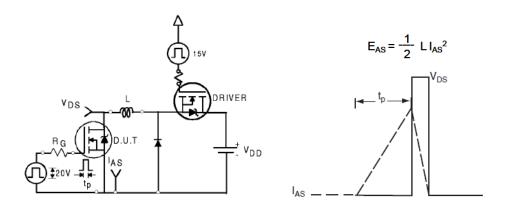
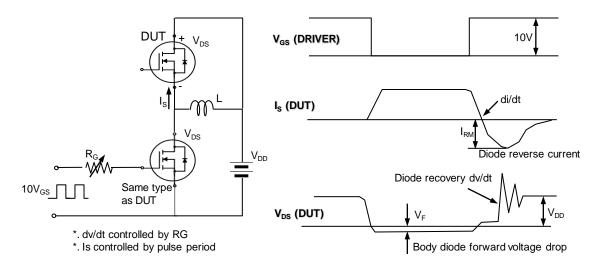


Fig 13. Peak diode recovery dv/dt test circuit & waveform



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